

## Inverting Dual ( $-V_{IN}$ , $-2V_{IN}$ ) Charge Pump Voltage Converters with Shutdown

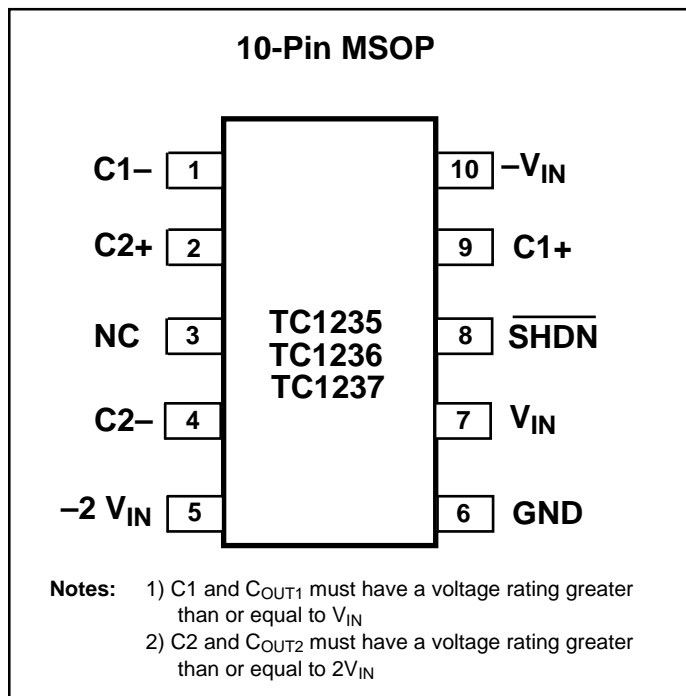
### FEATURES

- 10-Pin MSOP Package
- Operates from 1.8V to 5.5V
- Up to 5mA Output Current at  $-V_{IN}$  Pin
- Up to 1mA Output Current at  $-2V_{IN}$  Pin
- Power-Saving Shutdown Mode
- $-V_{IN}$  and  $-2V_{IN}$  Outputs Available
- Low Active Supply Current
  - ..... 120 $\mu$ A (MAX) for TC1235
  - ..... 360 $\mu$ A (MAX) for TC1236
  - ..... 1.5mA (MAX) for TC1237
- Fully Compatible with 1.8V Logic Systems

### TYPICAL APPLICATIONS

- LCD Panel Bias
- Cellular Phones PA Bias
- Pagers
- PDAs, Portable Dataloggers
- Battery Powered Devices

### PIN CONFIGURATION



### GENERAL DESCRIPTION

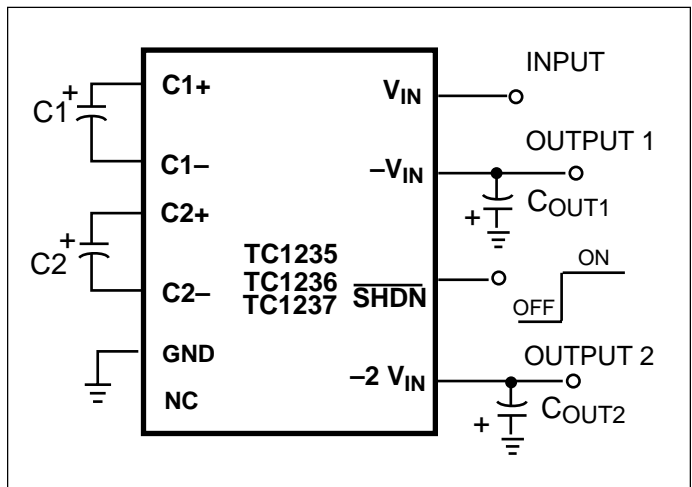
The TC1235/1236/1237 are CMOS dual inverting charge pump voltage converters with a low power shutdown mode in MSOP 10-Pin packages. Only four external capacitors are required for full circuit implementation. Switching frequencies are 12kHz for the TC1235, 35kHz for the TC1236 and 125kHz for the TC1237. When the shutdown pin is held at a logic low, the device goes into a very low power mode of operation, consuming less than 1 $\mu$ A of supply current.

These devices provide both a negative voltage inversion (available at the  $-V_{IN}$  output), and a negative doubling voltage inversion (available at the  $-2 V_{IN}$  output) with a low output impedance capable of providing output currents up to 5mA for the  $-V_{IN}$  output and 1mA for the  $-2V_{IN}$  output. The input voltage can range from +1.8V to +5.5V.

### ORDERING INFORMATION

| Part No.  | Package     | Osc Freq (KHz) | Temp Range     |
|-----------|-------------|----------------|----------------|
| TC1235EUN | 10-Pin MSOP | 12             | -40°C to +85°C |
| TC1236EUN | 10-Pin MSOP | 35             | -40°C to +85°C |
| TC1237EUN | 10-Pin MSOP | 125            | -40°C to +85°C |

### TYPICAL OPERATING CIRCUIT



# Inverting Dual ( $-V_{IN}$ , $-2V_{IN}$ ) Charge Pump Voltage Converters with Shutdown

**TC1235**  
**TC1236**  
**TC1237**

## ABSOLUTE MAXIMUM RATINGS\*

Input Voltage ( $V_{IN}$  to GND) ..... +6.0V, - 0.3V  
Output Voltage ( $-V_{IN}$ ,  $-2V_{IN}$  to GND) ..... -12.0V, + 0.3V  
Current at  $-V_{IN}$ ,  $-2V_{IN}$  Pins ..... 10mA  
Short-Circuit Duration  $-V_{IN}$ ,  $-2V_{IN}$  to GND ..... Indefinite  
Operating Temperature Range ..... - 40°C to +85°C

Power Dissipation ( $T_A \leq 70^\circ\text{C}$ ) MSOP-10 ..... 320mW  
Storage Temperature (Unbiased) ..... - 65°C to +150°C  
Lead Temperature (Soldering, 10sec) ..... +260°C

\*This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**ELECTRICAL CHARACTERISTICS:**  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ ,  $V_{IN} = +5\text{V}$ ,  $C1 = 3.3\mu\text{F}$ ,  $C2 = 1\mu\text{F}$  (TC1235);  $C1 = 1\mu\text{F}$ ,  $C2 = 0.33\mu\text{F}$  (TC1236);  $C1 = 0.33\mu\text{F}$ ,  $C2 = 0.1\mu\text{F}$  (TC1237),  $\overline{\text{SHDN}} = V_{IN}$ , unless otherwise noted. Typical values are at  $T_A = +25^\circ\text{C}$ .

| Symbol            | Parameter  | Device | Test Conditions  | Min  | Typ  | Max  | Unit            |
|-------------------|--|--------|--|------|------|------|-----------------|
| I <sub>DD</sub>   | Supply Current                                   | TC1235 | $\overline{\text{SHDN}} = V_{IN}$  | —    | 75   | 120  | $\mu\text{A}$   |
|                   |  | TC1236 | $\overline{\text{SHDN}} = V_{IN}$  | —    | 200  | 360  |                 |
|                   |  | TC1237 | $\overline{\text{SHDN}} = V_{IN}$  | —    | 625  | 1500 |                 |
| I <sub>SHDN</sub> | Shutdown Supply Current                          | All    | $\overline{\text{SHDN}} = \text{GND}$ , $V_{IN} = +5\text{V}$  | —    | 0.1  | 1    | $\mu\text{A}$   |
| V <sub>MIN</sub>  | Minimum Supply Voltage                           | All    | R <sub>LOAD</sub> = 1k $\Omega$ for $-V_{IN}$ output<br>R <sub>LOAD</sub> = 10k $\Omega$ for $-2V_{IN}$ output | 1.8  | —    | —    | V               |
| V <sub>MAX</sub>  | Maximum Supply Voltage                           | All    | R <sub>LOAD</sub> = 1k $\Omega$ for $-V_{IN}$ output<br>R <sub>LOAD</sub> = 10k $\Omega$ for $-2V_{IN}$ output | —    | —    | 5.5  | V               |
| F <sub>OSC</sub>  | Oscillator Frequency                             | TC1235 |  | 8.4  | 12   | 15.6 | kHz             |
|                   |  | TC1236 |  | 24.5 | 35   | 45.5 |                 |
|                   |  | TC1237 |  | 65   | 125  | 170  |                 |
| V <sub>IH</sub>   | Shutdown Input Logic High                        | All    | $V_{IN} = V_{MIN}$ to $V_{MAX}$  | 1.4  | —    | —    | V               |
| V <sub>IL</sub>   | Shutdown Input Logic low                         | All    | $V_{IN} = V_{MIN}$ to $V_{MAX}$  | —    | —    | 0.4  | V               |
| V <sub>EFF1</sub> | Voltage Conversion Efficiency (Stage 1)          | All    | R <sub>LOAD</sub> = $\infty$ for $-V_{IN}$ output<br>R <sub>LOAD</sub> = $\infty$ for $-2V_{IN}$ output        | 96   | 99.5 | —    | %               |
| V <sub>EFF2</sub> | Voltage Conversion Efficiency (Stage 2)          | All    | R <sub>LOAD</sub> = $\infty$ for $-V_{IN}$ output<br>R <sub>LOAD</sub> = $\infty$ for $-2V_{IN}$ output        | 94   | 99   | —    | %               |
| R <sub>OUT1</sub> | Output Resistance for $-V_{IN}$ output (Note 1)  | All    | I <sub>LOAD</sub> = 0.5mA to 5mA<br>No Load at $-V_{IN}$ Output  | —    | 45   | 80   | $\Omega$        |
| R <sub>OUT2</sub> | Output Resistance for $-2V_{IN}$ output (Note 1) | All    | I <sub>LOAD</sub> = 0.1mA to 1mA<br>No Load at $-2V_{IN}$ Output   | —    | 135  | 420  | $\Omega$        |
| T <sub>WK1</sub>  | Wake-Up Time From Shutdown Mode Stage 1          | TC1235 | R <sub>LOAD</sub> = 1k $\Omega$ for $-V_{IN}$ Output   | —    | 650  | —    | $\mu\text{sec}$ |
|                   |  | TC1236 | R <sub>LOAD</sub> = 10k $\Omega$ for $-2V_{IN}$ Output   | —    | 250  | —    |                 |
|                   |  | TC1237 |  | —    | 100  | —    |                 |
| T <sub>WK2</sub>  | Wake-Up Time From Shutdown Mode Stage 2          | TC1235 | R <sub>LOAD</sub> = 1k $\Omega$ for $-V_{IN}$ Output   | —    | 750  | —    | $\mu\text{sec}$ |
|                   |  | TC1236 | R <sub>LOAD</sub> = 10k $\Omega$ for $-2V_{IN}$ Output   | —    | 280  | —    |                 |
|                   |  | TC1237 |  | —    | 120  | —    |                 |

**NOTES:** 1. Capacitor contribution is approximately 20% of the output impedance [ESR = 1 / pump frequency x capacitance].

## PIN DESCRIPTION

| Pin Number | Name                     | Description   |
|------------|--------------------------|---|
| 1          | C1-                      | C1 Commutation Capacitor Negative Terminal.                   |
| 2          | C2+                      | C2 Commutation Capacitor Positive Terminal.                   |
| 3          | NC                       | No Connection.  |
| 4          | C2-                      | C2 Commutation Capacitor Negative Terminal.                   |
| 5          | $-2V_{IN}$               | Doubling Inverting Charge Pump Output ( $-2 \times V_{IN}$ ). |
| 6          | GND                      | Ground.   |
| 7          | $V_{IN}$                 | Positive Power Supply Input.                                  |
| 8          | $\overline{\text{SHDN}}$ | Shutdown Input (Active Low).                                  |
| 9          | C1+                      | C1 Commutation Capacitor Positive Terminal.                   |
| 10         | $-V_{IN}$                | Inverting Charge Pump Output ( $-1 \times V_{IN}$ ).          |

## DETAILED DESCRIPTION

The TC1235/1236/1237 dual charge pump converters perform both a  $-1\times$  and  $-2\times$  multiply of the voltage applied to the  $V_{IN}$  pin. Output ' $-V_{IN}$ ' provides a negative voltage inversion of the  $V_{IN}$  supply, while output ' $-2V_{IN}$ ' provides a negative doubling inversion of  $V_{IN}$ . Conversion is performed using two **synchronous** switching matrices and four external capacitors. When the shutdown input is held at a logic low both stages go into a very low power mode of operation consuming less than 1uA of supply current.

Figure 1 (below) is a block diagram representation of the TC1235/1236/1237 architecture. The first switching stage inverts the voltage present at  $V_{IN}$  and the second stage uses the ' $-V_{IN}$ ' output generated from the first stage to produce the ' $-2V_{IN}$ ' output function from the second stage switching matrix.

Each device contains an on-board oscillator that synchronously controls the operation of the charge pump switching matrices. The TC1235 synchronously switches at 12KHz, the TC1236 synchronously switches at 35KHz, and the TC1237 synchronously switches at 125KHz. The different oscillator frequencies for this device family allow the user to trade-off capacitor size versus supply current. Faster oscillators can use smaller external capacitors but will consume more supply current (see Electrical Characteristics Table).

When the shutdown input is in a low state, the oscillator and both switch matrices are powered off placing the TC1235/1236/1237 in the shutdown mode. When the  $V_{IN}$  supply input is powered from an external battery, the shutdown mode minimizes power consumption, which in turn will extend the life of the battery.

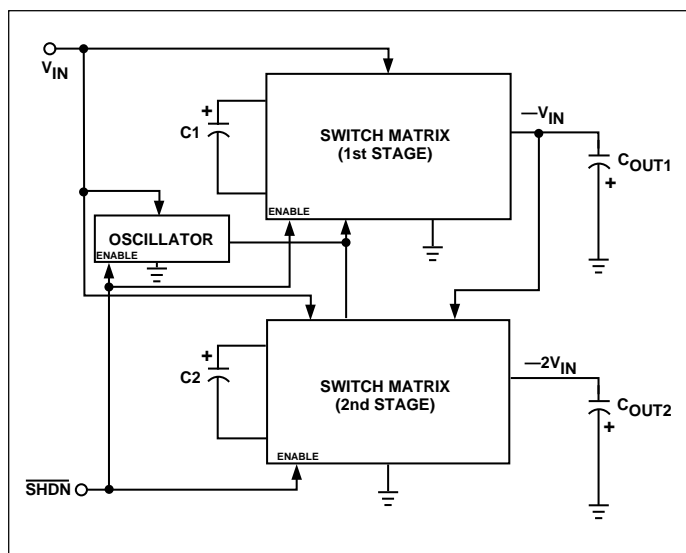


Figure 1. Functional Block Diagram

## APPLICATIONS INFORMATION

### Output Voltage Considerations

The TC1235/1236/1237 performs voltage conversions but does not provide any type of regulation. The two output voltage stages will droop in a linear manner with respect to their respective load currents. The value of the equivalent output resistance of the ' $-V_{IN}$ ' output is approximately 50Ω nominal at +25°C and  $V_{IN} = +5V$ . The value of the ' $-2V_{IN}$ ' output and is approximately 140Ω nominal at +25°C and  $V_{IN} = +5V$ . In this particular case, ' $-V_{IN}$ ' is approximately  $-5V$  and ' $-2V_{IN}$ ' is approximately  $-10V$  at very light loads, and each stage will droop according to the equation below:

$$V_{DROOP} = I_{OUT} \times R_{OUT}$$

$$[-V_{IN} \text{ OUTPUT}] = V_{OUT1} = -(V_{IN} - V_{DROOP1})$$

$$[-2V_{IN} \text{ OUTPUT}] = V_{OUT2} = V_{OUT1} - (V_{IN} - V_{DROOP2})$$

where  $V_{DROOP1}$  is the output voltage droop contributed from stage 1 loading, and  $V_{DROOP2}$  is the output voltage droop from stage 2 loading.

### Charge Pump Efficiency

The overall power efficiency of the two charge pump stages is affected by four factors:

- (1) Losses from power consumed by the internal oscillator, switch drive, etc. (which vary with input voltage, temperature and oscillator frequency).
- (2)  $I^2R$  losses due to the on-resistance of the MOSFET switches on-board each charge pump.
- (3) Charge pump capacitor losses due to effective series resistance (ESR).
- (4) Losses that occur during charge transfer (from the commutation capacitor to the output capacitor) when a voltage difference between the two capacitors exists.

Most of the conversion losses are due to factor (2), (3) and (4) above. The losses for the first stage are given by Equation 1a and the losses for the second stage are given by Equation 1b.

$$P_{1, \text{LOSS (2, 3, 4)}} = I_{OUT1}^2 \times R_{OUT1}$$

$$\text{where } R_{OUT1} = \left[ \frac{1}{f_{OSC}(C1)} \right] + 8R_{SWITCH1} + 4ESR_{C1} + ESR_{COUT1}$$

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**TC1237**

$$P_{2LOSS(2,3,4)} = I_{OUT2}^2 \times R_{OUT2}$$

where  $R_{OUT2} = [ 1 / [f_{OSC}(C2)] + 8R_{SWITCH2} + 4ESR_{C2} + ESR_{COUT2} ]$

**Equation 1b.**

The internal switch resistance for the first stage (i.e.  $R_{SWITCH1}$ ) is approximately  $3\Omega$  and the switch resistance for the second stage (i.e.  $R_{SWITCH2}$ ) is approximately  $7\Omega$ .

The losses in the circuit due to factor (4) above are also shown in Equation 2a for stage 1 and Equation 2b for stage 2. The output voltage ripple for stage 1 is given by Equation 3a and the output voltage ripple for stage 2 is given by Equation 3b.

$$P_{LOSS1(4)} = [ (0.5)(C1)(V_{IN}^2 - V_{OUT1}^2) + (0.5)(C_{OUT1})(V_{RIPPLE1}^2 - 2V_{OUT1}V_{RIPPLE1}) ] \times f_{OSC}$$

**Equation 2a.**

$$P_{LOSS2(4)} = [ (0.5)(C2)(V_{IN}^2 - V_{OUT2}^2) + (0.5)(C_{OUT2})(V_{RIPPLE2}^2 - 2V_{OUT2}V_{RIPPLE2}) ] \times f_{OSC}$$

**Equation 2b.**

$$V_{RIPPLE1} = [ I_{OUT1} / (f_{OSC})(C_{OUT1}) ] + 2(I_{OUT1})(ESR_{COUT1})$$

**Equation 3a.**

$$V_{RIPPLE2} = [ I_{OUT2} / (f_{OSC})(C_{OUT2}) ] + 2(I_{OUT2})(ESR_{COUT2})$$

**Equation 3b.**

## Capacitor Selection

In order to maintain the lowest output resistance and output ripple voltage, it is recommended that low ESR capacitors be used. Additionally, larger values of C1 and C2 will lower the output resistance and larger values of  $C_{OUT1}$  and  $C_{OUT2}$  will reduce output ripple. (See Equations 1a, 1b, 3a, and 3b). **NOTE: For proper charge pump operation, C1 and  $C_{OUT1}$  must have a voltage rating greater than or equal to  $V_{IN}$ , while C2 and  $C_{OUT2}$  must have a voltage rating greater than or equal to  $2V_{IN}$ .**

Table 1a shows various values of C1 and the corresponding output resistance values for  $V_{IN}=5V$  @  $+25^\circ C$  for stage 1 and Table 1b shows various values of C2 and the corresponding output resistance values for  $V_{IN}=5V$  @  $+25^\circ C$  for stage 2. It assumes a  $0.1\Omega$   $ESR_{C1}$ , a  $0.1\Omega$   $ESR_{C2}$ , a  $3\Omega$   $R_{SWITCH1}$ , and a  $7\Omega$   $R_{SWITCH2}$ .

Table 2a shows the output voltage ripple for various values of  $C_{OUT1}$  and Table 2b shows the output voltage ripple for various values of  $C_{OUT2}$  (again assuming  $V_{IN} = 5V$  @  $+25^\circ C$ ). The  $V_{RIPPLE1}$  values assume a  $3mA$  output load current for stage 1 and a  $0.1\Omega$   $ESR_{COUT1}$ . The  $V_{RIPPLE2}$  values assume a  $200\mu A$  output load current for stage 2 and a  $0.1\Omega$   $ESR_{COUT1}$ .

**Table 1a. Output Resistance vs. C1 (ESR = 0.1 $\Omega$ ). For Stage 1**

| C1 ( $\mu F$ ) | TC1235 $R_{OUT}$ ( $\Omega$ ) | TC1236 $R_{OUT}$ ( $\Omega$ ) | TC1237 $R_{OUT}$ ( $\Omega$ ) |
|----------------|-------------------------------|-------------------------------|-------------------------------|
| 0.47           | 202                           | 85                            | 42                            |
| 1              | 108                           | 53                            | 33                            |
| 3.3            | 50                            | 33                            | 27                            |

**Table 1b. Output Resistance vs. C2 (ESR = 0.1 $\Omega$ ). For Stage 2**

| C2 ( $\mu F$ ) | TC1235 $R_{OUT}$ ( $\Omega$ ) | TC1236 $R_{OUT}$ ( $\Omega$ ) | TC1237 $R_{OUT}$ ( $\Omega$ ) |
|----------------|-------------------------------|-------------------------------|-------------------------------|
| 0.1            | 890                           | 342                           | 137                           |
| 0.47           | 239                           | 117                           | 74                            |
| 1              | 140                           | 85                            | 65                            |

**Table 2a. Output Voltage Ripple vs.  $C_{OUT1}$  (ESR = 0.1 $\Omega$ ) For Stage 1  
( $I_{OUT1} = 3mA$ )**

| $C_{OUT1}$ ( $\mu F$ ) | TC1235 $V_{RIPPLE1}$ (mV) | TC1236 $V_{RIPPLE1}$ (mV) | TC1237 $V_{RIPPLE1}$ (mV) |
|------------------------|---------------------------|---------------------------|---------------------------|
| 0.47                   | 533                       | 183                       | 52                        |
| 1                      | 251                       | 86                        | 25                        |
| 3.3                    | 76                        | 27                        | 8                         |

**Table 2b. Output Voltage Ripple vs.  $C_{OUT2}$  (ESR = 0.1 $\Omega$ ) For Stage 2  
( $I_{OUT2} = 200\mu A$ )**

| $C_{OUT2}$ ( $\mu F$ ) | TC1235 $V_{RIPPLE2}$ (mV) | TC1236 $V_{RIPPLE2}$ (mV) | TC1237 $V_{RIPPLE2}$ (mV) |
|------------------------|---------------------------|---------------------------|---------------------------|
| 0.1                    | 167                       | 57                        | 16                        |
| 0.47                   | 36                        | 12                        | 3.4                       |
| 1                      | 17                        | 5.8                       | 1.6                       |

# Inverting Dual ( $-V_{IN}$ , $-2V_{IN}$ ) Charge Pump Voltage Converters with Shutdown

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## Input Supply Bypassing

The  $V_{IN}$  input should be capacitively bypassed to reduce AC impedance and minimize noise effects due to the switching internal to the device. It is recommended that a large value capacitor (at least equal to  $C_1$ ) be connected from  $V_{IN}$  to GND for optimal circuit performance.

## Shutdown Input

The TC12351/1236/1237 is enabled when /SHDN is high, and disabled when /SHDN is low. This input cannot be allowed to float. (If /SHDN is not required, see the TC1225/1226/1227 data sheet.) The /SHDN input should be limited to 0.3V above  $V_{IN}$  to avoid significant current flows.

## Dual Voltage Inverter

The most common application for the TC1235/1236/1237 devices is the dual voltage inverter (Figure 2). This application uses four external capacitors:  $C_1$ ,  $C_2$ ,  $C_{OUT1}$ , and  $C_{OUT2}$  (NOTE: a power supply bypass capacitor is recommended). The outputs are equal to  $-V_{IN}$  and  $-2V_{IN}$  plus any voltage drops due to loading. Refer to Tables 1a, 1b, 2a, and 2b for capacitor selection guidelines.

## Layout Considerations

As with any switching power supply circuit good layout practice is recommended. Mount components as close together as possible to minimize stray inductance and capacitance. Also use a large ground plane to minimize noise leakage into other circuitry.

## TC1235 DEMO Card

The TC1235 DEMO Card is a 2.0" x 2.0" card containing both a TC1235 and two cascaded TC1219s that allow the user to compare the operation of each approach for generating a  $-1X$  and  $-2X$  function. Each circuit is fully assembled with the required external capacitors along with variable load resistors that allow the user to vary the output load current of each stage. For convenience, several test points and jumpers are available for measuring various voltages and currents on the demo board.

Figure 3 is a schematic of the TC1235 DEMO Card, and Figure 4 shows the assembly drawing and artwork for the board. Table 3 lists the voltages that are monitored by the test points and Table 4 lists the currents that can be measured using the jumpers.

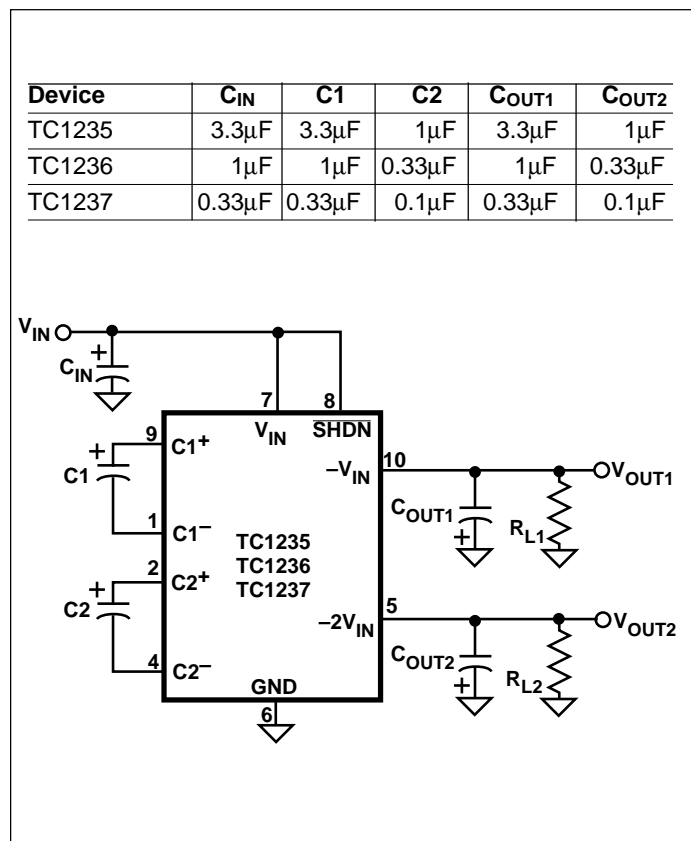


Figure 2. Dual Voltage Inverter Test Circuit

Table 3. TC1235 DEMO Card Test Points

| TEST POINT | VOLTAGE MEASUREMENT             |
|------------|---------------------------------|
| TP1        | VIN [+5V]                       |
| TP2        | GROUND                          |
| TP3        | GROUND                          |
| TP4        | TC1219 U1 OUTPUT [-5V(1)]       |
| TP5        | TC1219 U2 OUTPUT [-10V(1)]      |
| TP6        | TC1235 STAGE 1 OUTPUT [-5V(2)]  |
| TP7        | TC1235 STAGE 2 OUTPUT [-10V(2)] |
| TP8        | EXTERNAL /SHDN INPUT            |
| TP9        | TC1219 U1 /SHDN INPUT           |
| TP10       | TC1235 U3 /SHDN INPUT           |

Table 4. TC1235 DEMO Card Jumpers

| JUMPER | CURRENT MEASUREMENT                   |
|--------|---------------------------------------|
| J1     | DUAL TC1219 QUIESCENT CURRENT         |
| J2     | TC1235 QUIESCENT CURRENT              |
| J3     | TC1219 U1 [-5V(1)] LOAD CURRENT       |
| J4     | TC1219 U2 [-10V(1)] LOAD CURRENT      |
| J5     | TC1235 STAGE 1 [-5V(2)] LOAD CURRENT  |
| J6     | TC1235 STAGE 2 [-10V(2)] LOAD CURRENT |
| J7     | TC1219 U1 /SHDN INPUT CURRENT         |
| J8     | TC1235 U3 /SHDN INPUT CURRENT         |
| J9     | GROUND EXTERNAL /SHDN INPUT           |

TC1235  
 TC1236  
 TC1237

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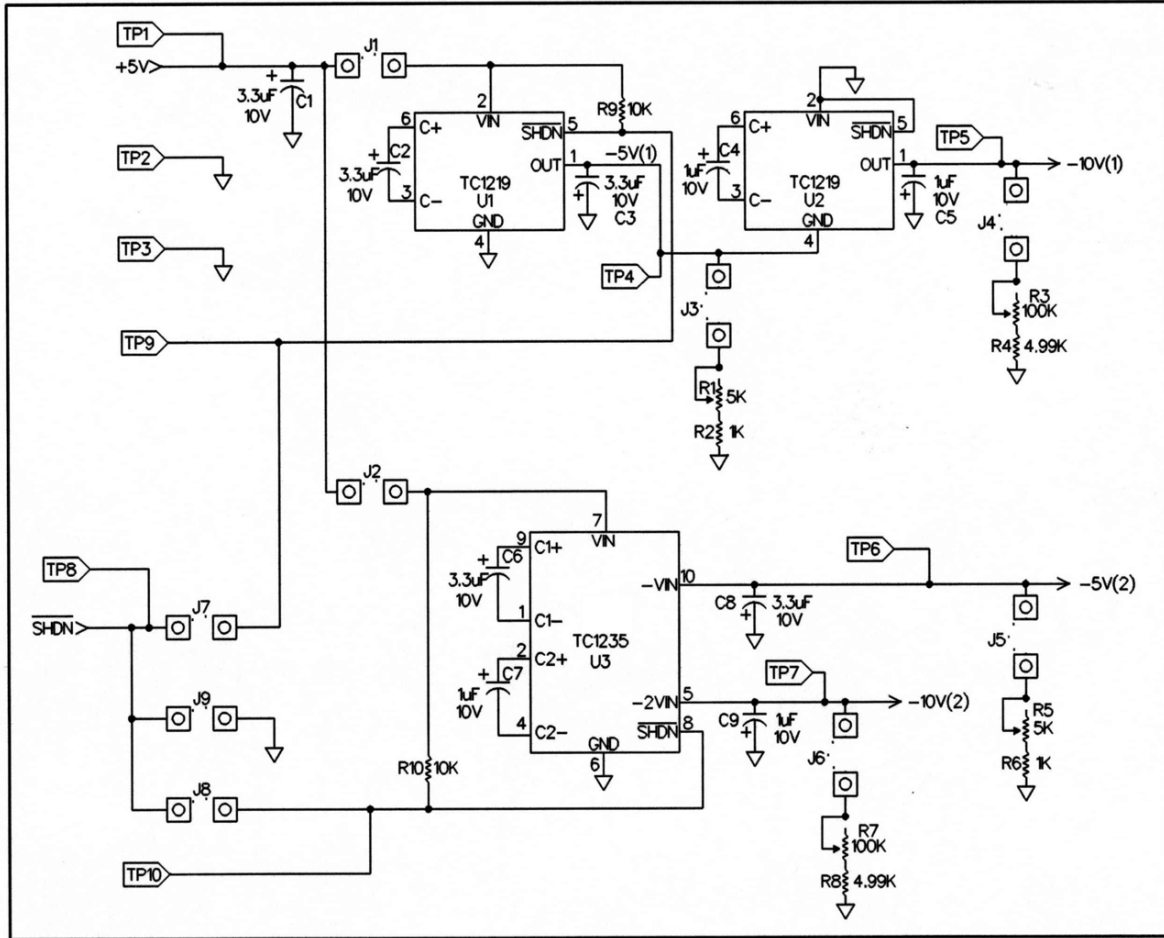


Figure 3. TC1235 DEMO Card Schematic

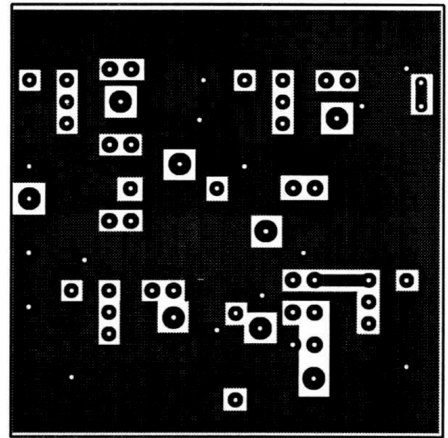
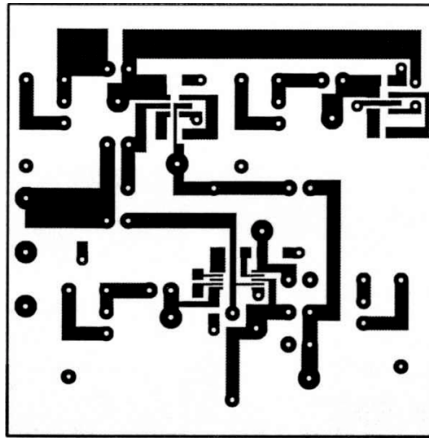
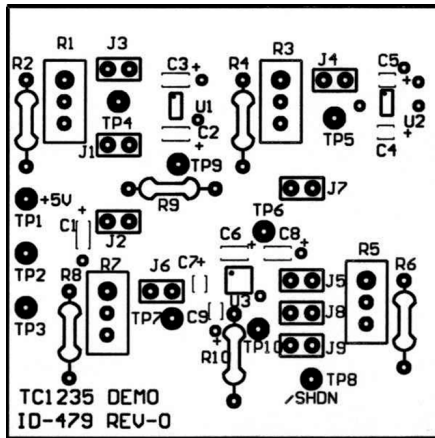
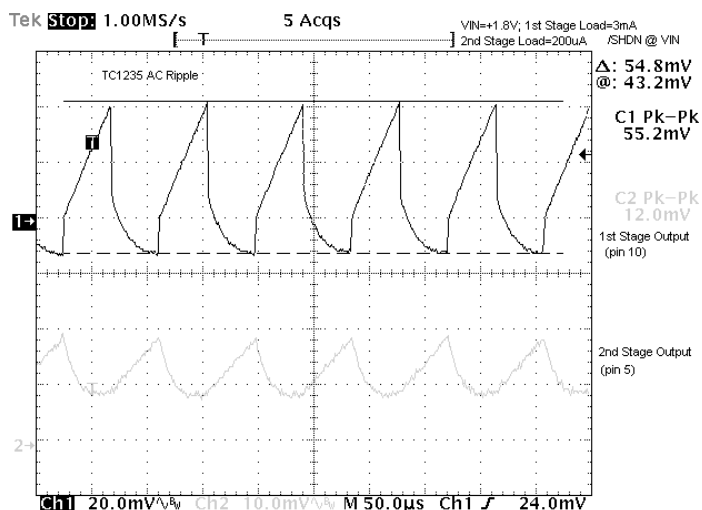
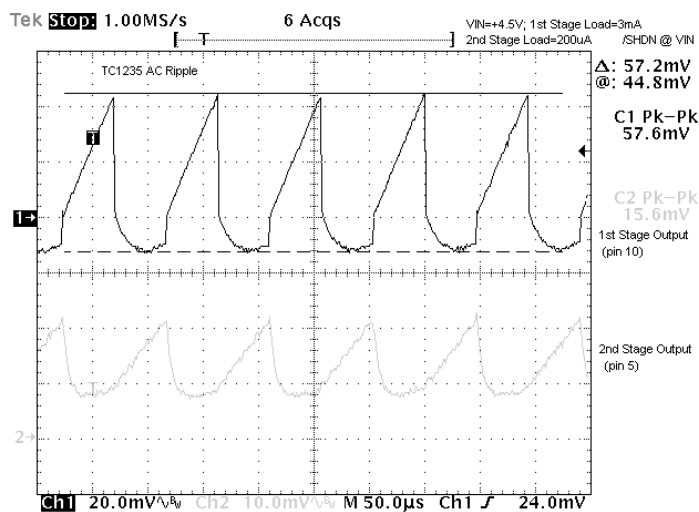
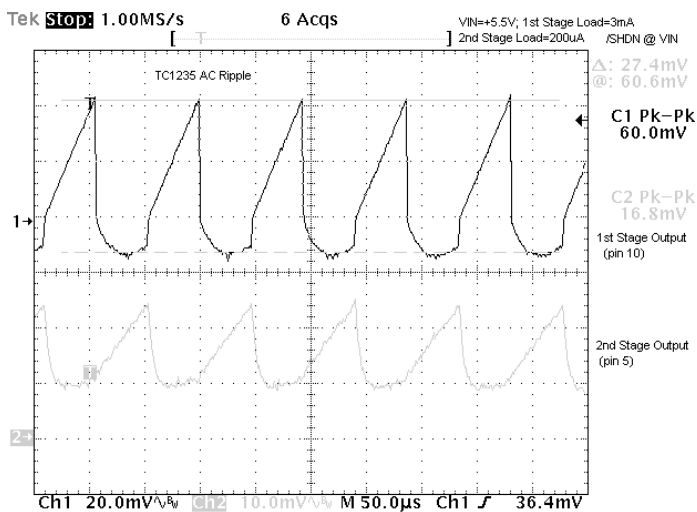
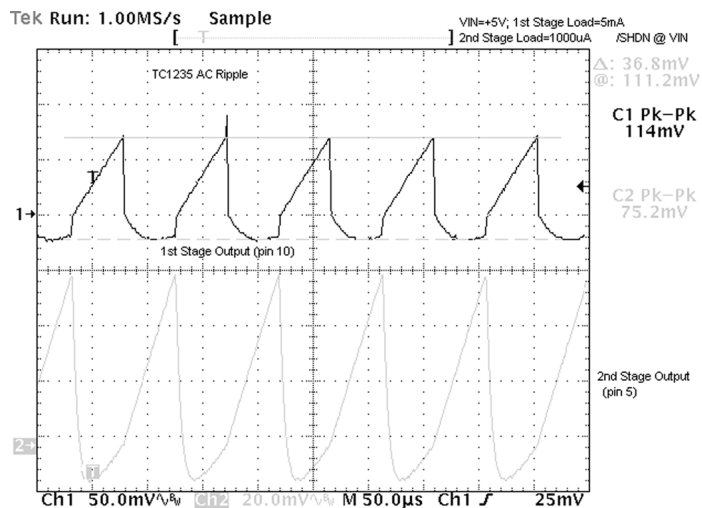
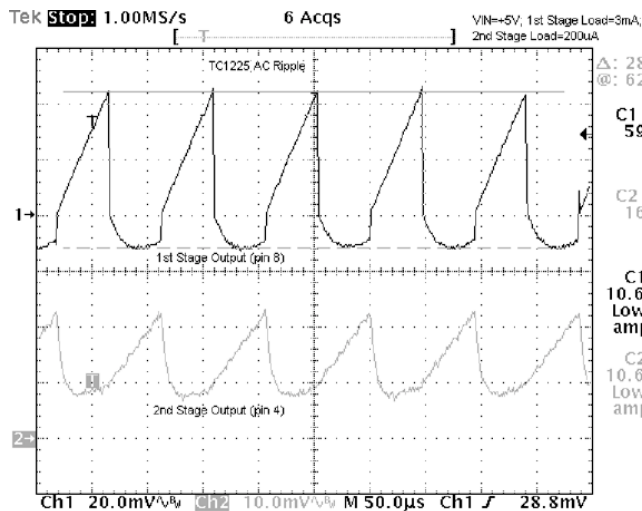


Figure 4. TC1235 DEMO Card Assembly Drawing and Artwork

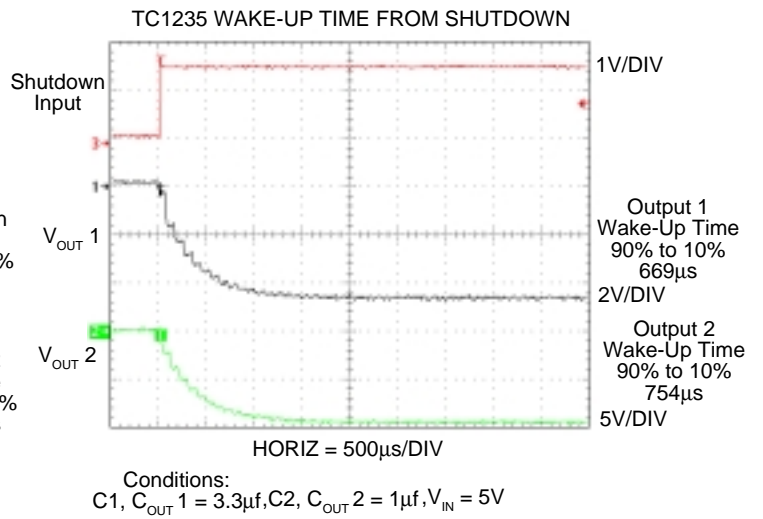
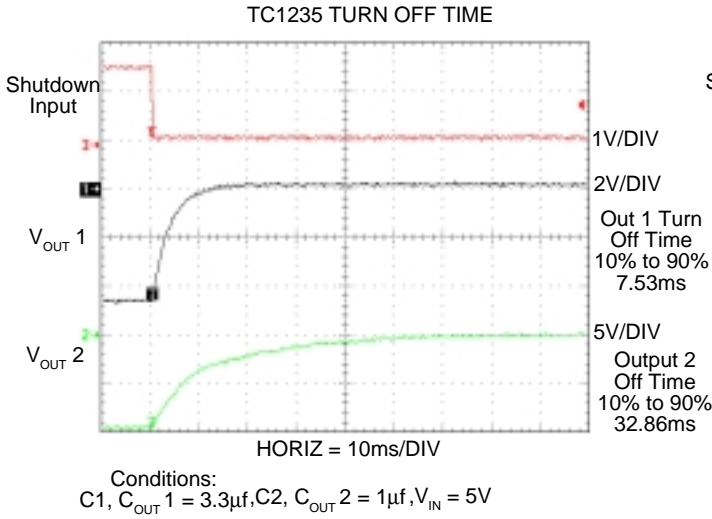
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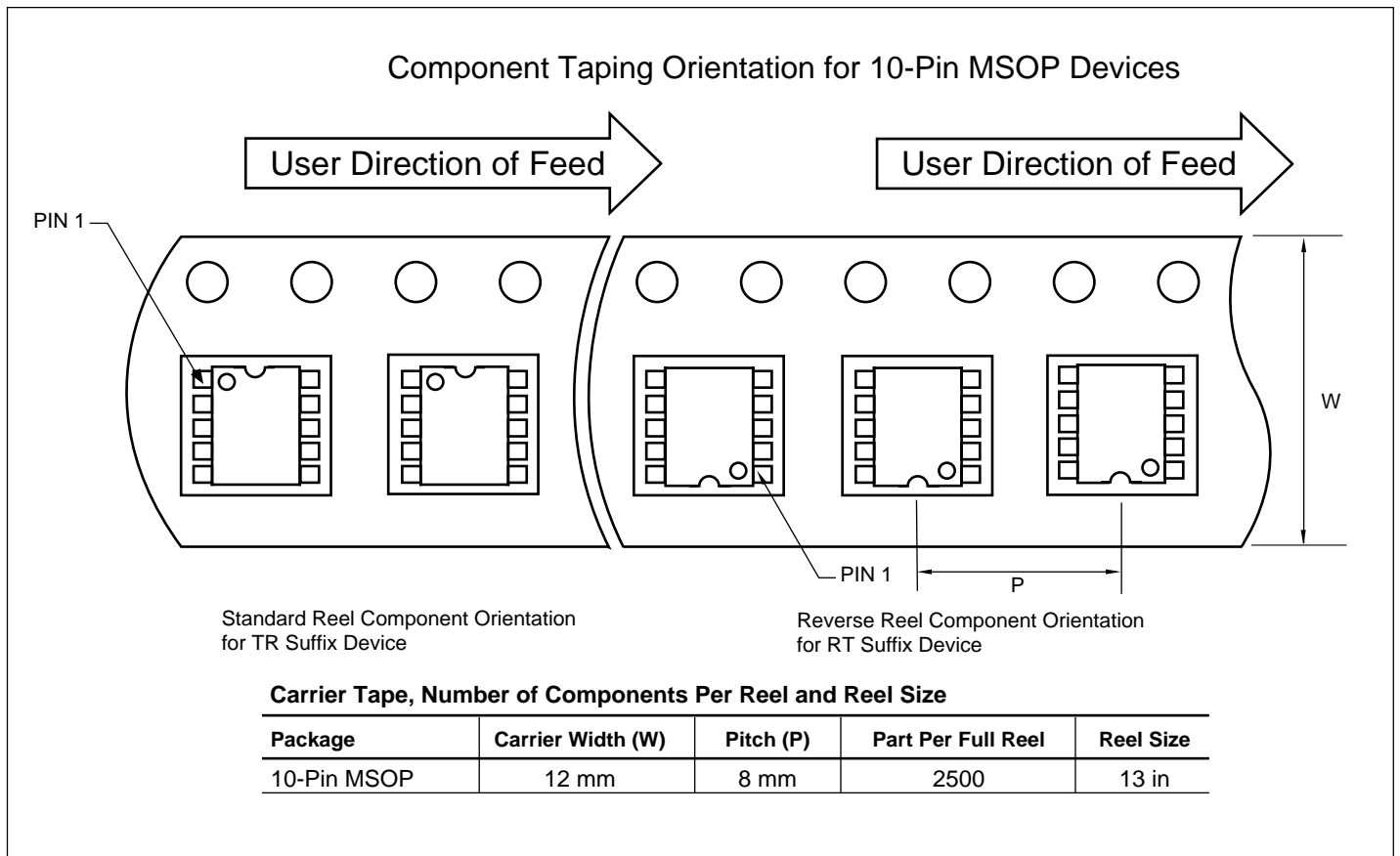
## TYPICAL RIPPLE WAVEFORMS



TYPICAL RIPPLE WAVEFORMS



TAPING FORM



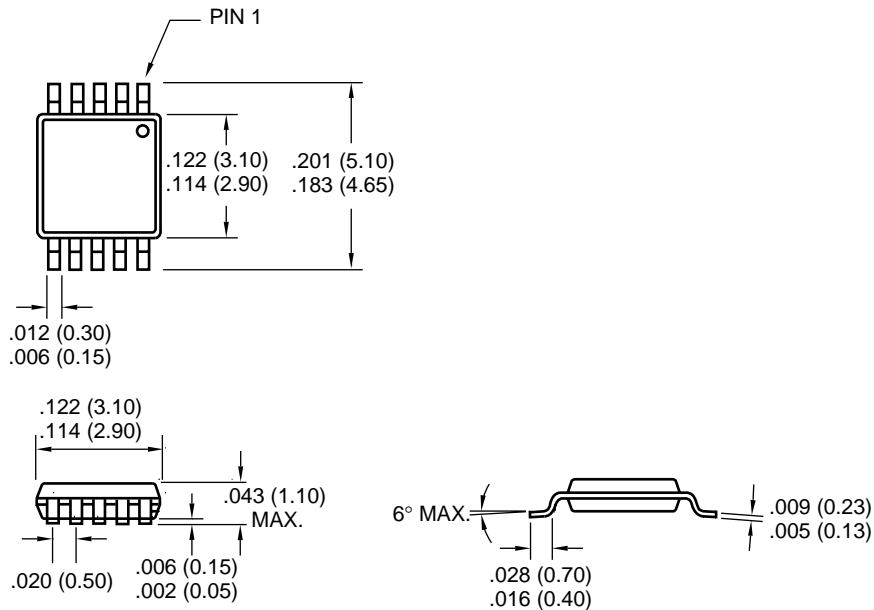


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TC1235  
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TC1237

## PACKAGE DIMENSIONS

### 10-Pin MSOP



Dimensions: inches (mm)



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